



# **Dual N-Channel 20-V (D-S) MOSFET**

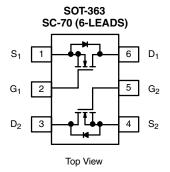
PRODUCT SUMMARY					
V <sub>DS</sub> (V)	r <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A)			
20	$0.385$ at $V_{GS} = 4.5 \text{ V}$	0.70			
	0.630 at V <sub>GS</sub> = 2.5 V	0.54			

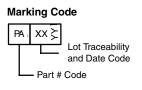
### **FEATURES**

TrenchFET<sup>®</sup> Power MOSFETS: 2.5 V Rated



RoHS COMPLIANT





Ordering Information: Si1902DL-T1 (with Tape and Reel) Si1902DL-T1-E3 (Lead (Pb)-free with Tape and Reel)

<b>ABSOLUTE MAXIMUM RATINGS</b> $T_A = 25$ °C, unless otherwise noted						
Parameter		Symbol	5 secs	Steady State	Unit	
Drain-Source Voltage		V <sub>DS</sub>	20		V	
Gate-Source Voltage		$V_{GS}$	±12			
Continuous Proin Comment /T 450 00\8	T <sub>A</sub> = 25 °C		0.70	0.66		
Continuous Drain Current (T <sub>J</sub> = 150 °C) <sup>a</sup>	T <sub>A</sub> = 85 °C	Ι <sub>D</sub>	0.50	0.48		
Pulsed Drain Current		I <sub>DM</sub>	1.0		Α	
Continuous Source Current (Diode Conduction) <sup>a</sup>		I <sub>S</sub>	0.25	0.23		
Maximum Power Dissipation <sup>a</sup>	T <sub>A</sub> = 25 °C	P <sub>D</sub>	0.30	0.27	W	
	T <sub>A</sub> = 85 °C	' D	0.16	0.14	VV	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150		°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Manianum lumation to Ambient	t ≤ 5 sec	R <sub>thJA</sub>	360	415	°C/W
Maximum Junction-to-Ambient <sup>a</sup>	Steady State		400	460	
Maximum Junction-to-Foot (Drain)	Steady State	$R_{thJF}$	300	350	

a. Surface Mounted on 1" x 1" FR4 Board.

<sup>\*</sup> Pb containing terminations are not RoHS compliant, exemptions may apply

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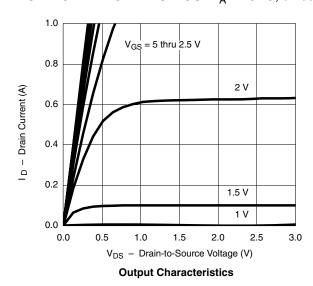
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit	
Static							
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	0.6		1.5	V	
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 16 V, V <sub>GS</sub> = 0 V	1		1		
		V <sub>DS</sub> = 16 V <sub>GS</sub> = 0 V, T <sub>J</sub> = 85°C	5			μA	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	1.0			Α	
Drain-Source On-State Resistance <sup>a</sup>		$V_{GS} = 4.5 \text{ V}, I_D = 0.66 \text{ A}$		0.320	0.385		
	r <sub>DS(on)</sub>	$V_{GS} = 2.5 \text{ V}, I_D = 0.40 \text{ A}$		0.560	0.630	Ω	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	$V_{DS} = 10 \text{ V}, I_D = 0.66 \text{ A}$		1.5		S	
Diode Forward Voltage <sup>a</sup>	$V_{SD}$	$I_S = 0.23 \text{ A}, V_{GS} = 0 \text{ V}$		0.8	1.2	V	
Dynamic <sup>b</sup>							
Total Gate Charge	$Q_g$			0.8	1.2		
Gate-Source Charge	$Q_{gs}$	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 0.66 \text{ A}$		0.06		nC	
Gate-Drain Charge	$Q_{gd}$			0.30			
Turn-On Delay Time	t <sub>d(on)</sub>			10	20		
Rise Time	t <sub>r</sub>	$V_{DD} = 10 \text{ V}, R_1 = 20 \Omega$		16	30	ns	
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_D\cong 0.5$ A, $V_{GEN}$ = 4.5 V, $R_G$ = 6 $\Omega$		10	20		
Fall Time	t <sub>f</sub>			10	20		
Source-Drain Reverse Recovery Time	t <sub>rr</sub>	$I_F = 0.23 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}$		20	40		

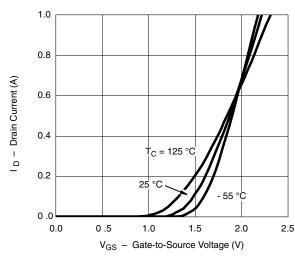
#### Notes:

- a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## **TYPICAL CHARACTERISTICS** $T_A = 25$ °C, unless otherwise noted





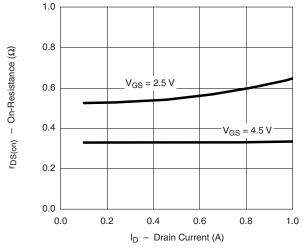
**Transfer Characteristics** 



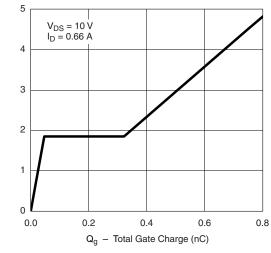
V<sub>GS</sub> - Gate-to-Source Voltage (V)

- Source Current (A)

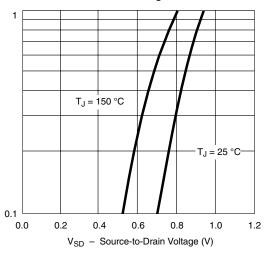
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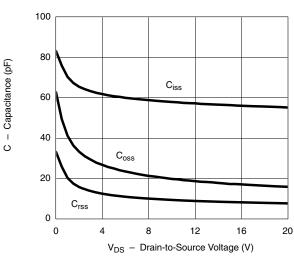
#### On-Resistance vs. Drain Current



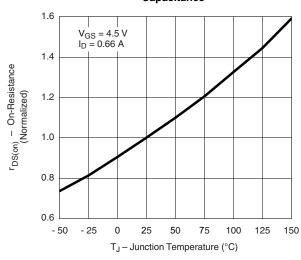
### **Gate Charge**



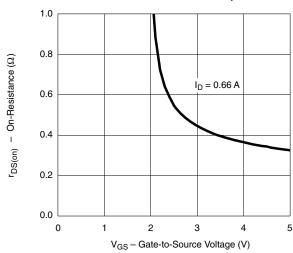
Surge-Drain Diode Forward Voltage



#### Capacitance



#### On-Resistance vs. Junction Temperature

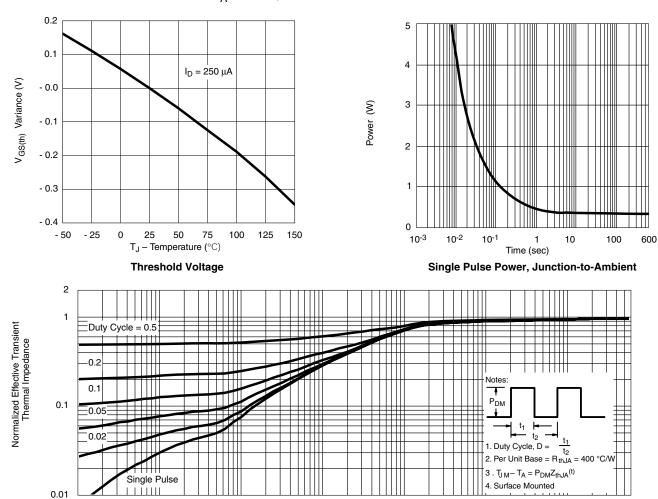


On-Resistance vs. Gate-to-Source Voltage

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Square Wave Pulse Duration (sec)

Normalized Thermal Transient Impedance, Junction-to-Ambient

10

100

600

10<sup>-1</sup>

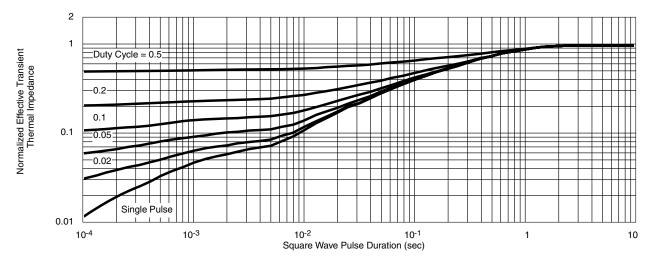
1 0 -2

10-3

10<sup>-4</sup>



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Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?71080">http://www.vishay.com/ppg?71080</a>.



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